## 2SB1389

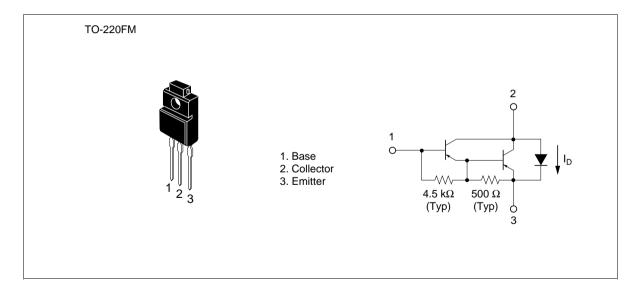
### Silicon PNP Triple Diffused

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#### Application

Low frequency power amplifier

#### Outline





#### 2SB1389

#### **Absolute Maximum Ratings** (Ta = $25^{\circ}$ C)

Item	Symbol		Unit	
Collector to base voltage	V <sub>CBO</sub>	-60	V	
Collector to emitter voltage	V <sub>CEO</sub>	-60	V	
Emitter to base voltage	$V_{\text{EBO}}$	-7	V	
Collector current	Ι <sub>c</sub>	-4	А	
Collector peak current	I <sub>C(peak)</sub>	-8	А	
Collector power dissipation	P <sub>c</sub>	2	W	
	P <sub>c</sub> * <sup>1</sup>	25		
Junction temperature	Tj	150	٥C	
Storage temperature	Tstg	-55 to +150	٥°	
C to E diode forward current	<mark>ا</mark> _* <sup>1</sup>	4	Α	
	D			

Note: 1. Value at  $T_c = 25^{\circ}C$ .

#### **Electrical Characteristics** (Ta = 25°C)

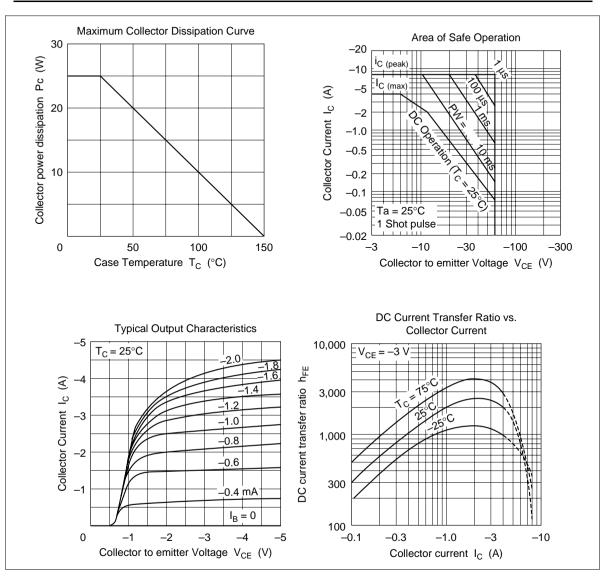
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	-60	_	—	V	$I_{c} = -0.1 \text{ mA}, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{\rm (BR)CEO}$	-60	_	—	V	$I_c = -25$ mA, $R_{\scriptscriptstyle BE} = \infty$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	-7	_	—	V	$I_{\rm E} = -50$ mA, $I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_		-10	μA	$V_{CB} = -50 \text{ V}, I_{E} = 0$
	I <sub>CEO</sub>	_		-10	_	$V_{ce} = -50$ V, $R_{be} = \infty$
DC current transfer ratio	h <sub>FE</sub>	1000		20000		$V_{ce} = -3 V, I_c = -2 A^{*1}$
Collector to emitter saturation	$V_{\text{CE(sat)1}}$	_	_	-1.5	V	$I_{\rm C} = -2$ A, $I_{\rm B} = -4$ mA <sup>*1</sup>
voltage	$V_{\text{CE(sat)2}}$	_		-3.0	_	$I_{\rm c} = -4$ A, $I_{\rm B} = -40$ mA <sup>*1</sup>
Base to emitter saturation	$V_{\text{BE(sat)1}}$	_		-2.0	V	$I_{\rm C} = -2$ A, $I_{\rm B} = -4$ mA <sup>*1</sup>
voltage	$V_{\text{BE(sat)2}}$	_	_	-3.5	_	$I_{\rm c} = -4$ A, $I_{\rm B} = -40$ mA <sup>*1</sup>
C to E diode forward voltage	V <sub>D</sub>	_		3.0	V	$I_{\rm D} = 4 \ {\rm A}^{*1}$

Note: 1. Pulse test.

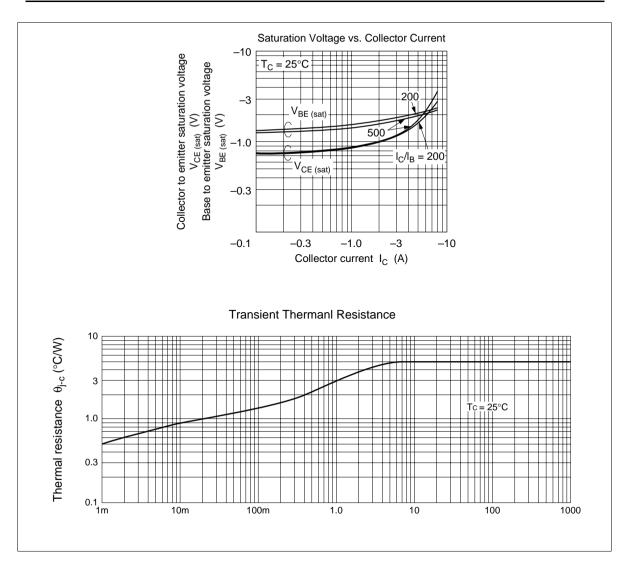
See switching characteristic curve of 2SB1101.

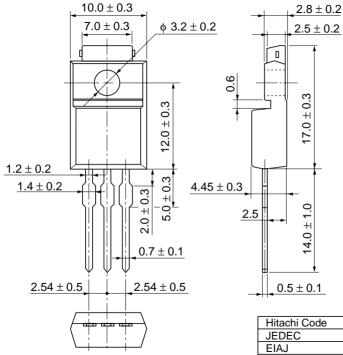
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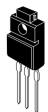


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Unit: mm



Hitachi Code	TO-220FM
JEDEC	
EIAJ	Conforms
Weight (reference value)	1.8 g

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